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Name....

B.TECH. DEGREE EXAMINATION, MAY 2015

Eighth Semester

Branch : Electronics and Communication Engineering/Electronics and Information Engineering EI 010 804 L02/EC 010 804 L02—MICRO ELECTRO MECHANICAL

SYSTEMS (Elective III) [EI/EC]

(New Scheme—2010 Admission onwards)

[Regular/Supplementary]

Time: Three Hours

Maximum: 100 Marks

Part A

Answer all questions.
Each question carries 3 marks.

- 1. Explain the multidisciplinary nature of MEMS.
- 2. Describe the method of micro sensors.
- 3. List out difference between MEMS and Microsystems.
- 4. Write short note on Photolithography.
- 5. Explain the LIGA process.

 $(5 \times 3 = 15 \text{ marks})$

Part B

Answer all questions.

Each question carries 5 marks.

- 6. Briefly explain about the typical MEMS products.
- 7. Describe microactuation with shape memory alloy.
- 8. Explain the Engineering Science and Microsystem design.
- 9. What are the micro systems fabrication process?
- 10. Differentiate dry etching and wet etching in bulk micromachining.

 $(5 \times 5 = 25 \text{ marks})$

Part C

Answer all questions.
Each question carries 12 marks.

11. Explain the difference between MEMS and Microsystems.

Or

- 12. Briefly explain the Evolution of Micro fabrication.
- 13. Describe the working of micro accelerometers.

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- 14. Write short notes on microfluidics.
- 15. Explain in detail about substrate and wafer involved in fabrication process.

Or

- 16. Describe the atomic structure of matter in MEMS devices.
- 17. Briefly explain the chemical vapour deposition.

Or

- 18. Explain the micro system fabrication process.
- 19. What are the mechanical problems associated with surface micromachining?

Or

20. Explain in detail about the LIGA process.

 $(5 \times 12 = 60 \text{ marks})$